### **Triacs**

### **Silicon Bidirectional Thyristors**

Designed for high performance full—wave ac control applications where high noise immunity and high commutating di/dt are required.

### **Features**

- Blocking Voltage to 800 Volts
- On–State Current Rating of 8.0 Amperes RMS at 100°C
- Uniform Gate Trigger Currents in Three Quadrants
- High Immunity to dv/dt 250 V/μs minimum at 125°C
- Minimizes Snubber Networks for Protection
- Industry Standard TO-220 Package
- High Commutating di/dt 6.5 A/ms minimum at 125°C
- These Devices are Pb-Free and are RoHS Compliant\*

### **MAXIMUM RATINGS** (T<sub>J</sub> = 25°C unless otherwise noted)

Characteristic	Symbol	Value	Unit
Peak Repetitive Off–State Voltage <sup>-</sup> (Note 1) (T <sub>J</sub> = -40 to 125°C, Sine Wave, 50 to 60 Hz, Gate Open)	$V_{DRM,} \ V_{RRM}$		V
MAC8DG MAC8MG MAC8NG		400 600 800	
On-State RMS Current, (Full Cycle Sine Wave, 60 Hz, T <sub>C</sub> = 100°C)	I <sub>T(RMS)</sub>	8.0	А
Peak Non-Repetitive Surge Current (One Full Cycle Sine Wave, 60 Hz, T <sub>J</sub> = 125°C)	I <sub>TSM</sub>	80	A
Circuit Fusing Consideration (t = 8.3 ms)	l <sup>2</sup> t	26	A <sup>2</sup> s
Peak Gate Power (Pulse Width ≤ 1.0 μs, T <sub>C</sub> = 80°C)	P <sub>GM</sub>	16	W
Average Gate Power (t = 8.3 ms, T <sub>C</sub> = 80°C)	P <sub>G(AV)</sub>	0.35	W
Operating Junction Temperature Range	T <sub>J</sub>	-40 to +125	°C
Storage Temperature Range	T <sub>stg</sub>	-40 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

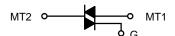
 V<sub>DRM</sub> and V<sub>RRM</sub> for all types can be applied on a continuous basis. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

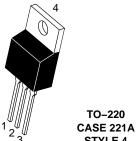


### ON Semiconductor®

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### TRIACS 8 AMPERES RMS 400 thru 800 VOLTS





MARKING DIAGRAM



STYLE 4

= D, M, or N

A = Assembly Location (Optional)\*

′ = Year

WW = Work Week

G = Pb-Free Package

\* The Assembly Location code (A) is optional. In cases where the Assembly Location is stamped on the package the assembly code may be blank.

PIN ASSIGNMENT				
1	Main Terminal 1			
2	Main Terminal 2			
3	Gate			
4	Main Terminal 2			

### **ORDERING INFORMATION**

Device	Package	Shipping
MAC8DG	TO-220 (Pb-Free)	50 Units / Rail
MAC8MG	TO-220 (Pb-Free)	50 Units / Rail
MAC8NG	TO-220 (Pb-Free)	50 Units / Rail

<sup>\*</sup>For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

### THERMAL CHARACTERISTICS

Characteristic		Value	Unit
Thermal Resistance, Junction-to-Case	$R_{ heta JC}$	2.2	°C/W
Thermal Resistance, Junction-to-Ambient	$R_{ heta JA}$	62.5	°C/W
Maximum Lead Temperature for Soldering Purposes 1/8" from Case for 10 Seconds	TL	260	°C

### FI FCTRICAL CHARACTERISTICS (T = 25°C unless otherwise noted: Electricals apply in both directions)

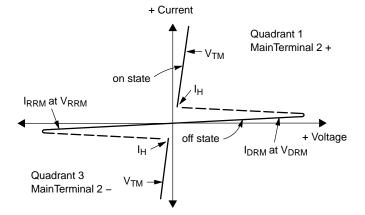
Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS		•	•		
Peak Repetitive Blocking Current ( $V_D$ = Rated $V_{DRM}$ , $V_{RRM}$ ; Gate Open) $T_J = 25^{\circ}C$ $T_J = 125^{\circ}C$	I <sub>DRM</sub> , I <sub>RRM</sub>	_ _	_ _	0.01 2.0	mA
ON CHARACTERISTICS		•	-		•
Peak On-State Voltage (Note 2), (I <sub>TM</sub> = ±11 A Peak)	$V_{TM}$	_	1.2	1.6	V
Gate Trigger Current (Continuous DC) ( $V_D$ = 12 V, $R_L$ = 100 $\Omega$ ) MT2(+), G(+) MT2(+), G(-) MT2(-), G(-)	I <sub>GT</sub>	5.0 5.0 5.0	13 16 18	35 35 35	mA
Holding Current, (V <sub>D</sub> = 12 V, Gate Open, Initiating Current = ±150 mA)	I <sub>H</sub>	-	20	40	mA
Latching Current ( $V_D = 24 \text{ V}, I_G = 35 \text{ mA}$ ), MT2(+), G(+); MT2(-), G(-) MT2(+), G(-)	ΙL	_ _	20 30	50 80	mA
Gate Trigger Voltage ( $V_D$ = 12 V, $R_L$ = 100 $\Omega$ ) MT2(+), G(+) MT2(+), G(-) MT2(-), G(-)	V <sub>GT</sub>	0.5 0.5 0.5	0.69 0.77 0.72	1.5 1.5 1.5	V
Gate Non–Trigger Voltage ( $V_D$ = 12 V, $R_L$ = 100 $\Omega$ , $T_J$ = 125°C) MT2(+), G(+); MT2(+), G(-); MT2(-), G(-)	$V_{GD}$	0.2	_	_	V
DYNAMIC CHARACTERISTICS				•	•
Rate of Change of Commutating Current See Figure 10.( $V_D$ = 400 V, $I_{TM}$ = 4.4 A, Commutating dv/dt = 18 V/ $\mu$ s,Gate Open, $T_J$ = 125°C, $f$ = 250 Hz, No Snubber) $C_L$ = 10 $\mu$ F $L_L$ = 40 mH	(di/dt) <sub>c</sub>	6.5	-	-	A/ms
Critical Rate of Rise of Off-State Voltage ( $V_D$ = Rated $V_{DRM}$ , Exponential Waveform, Gate Open, $T_J$ = 125°C)	dv/dt	250	-	-	V/μs

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

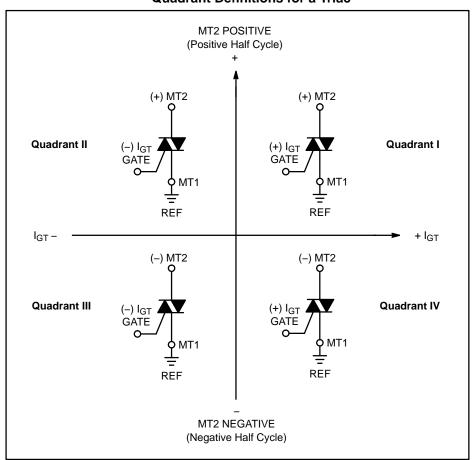
2. Indicates Pulse Test: Pulse Width ≤ 2.0 ms, Duty Cycle ≤ 2%.

## Voltage Current Characteristic of Triacs (Bidirectional Device)

Symbol	Parameter
V <sub>DRM</sub>	Peak Repetitive Forward Off State Voltage
I <sub>DRM</sub>	Peak Forward Blocking Current
$V_{RRM}$	Peak Repetitive Reverse Off State Voltage
I <sub>RRM</sub>	Peak Reverse Blocking Current
V <sub>TM</sub>	Maximum On State Voltage
I <sub>H</sub>	Holding Current



### **Quadrant Definitions for a Triac**



All polarities are referenced to MT1.

 $\dot{\text{With}}$  in–phase signals (using standard AC lines) quadrants I and III are used.

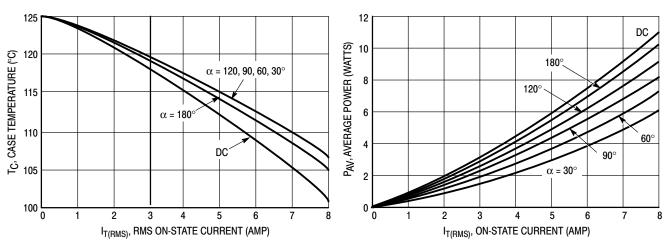


Figure 1. RMS Current Derating

Figure 2. On-State Power Dissipation

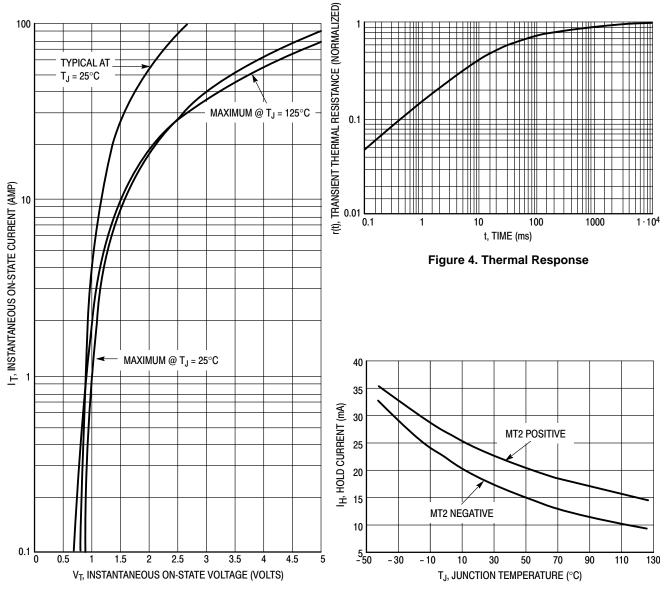
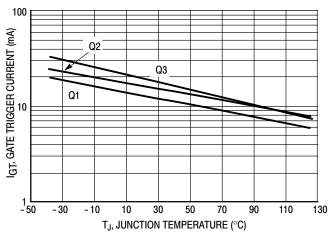


Figure 3. On-State Characteristics

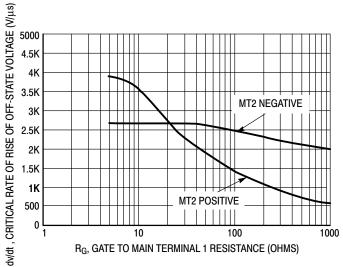
Figure 5. Hold Current Variation



Q2 0.95 VGT, GATE TRIGGER VOLTAGE (VOLT) 0.9 Q3 0.85 0.8 075 0.7 Q1 0.65 0.6 0.55 0.5 0.45 0.4 -50 50 70 90 -30 - 10 30 110 130 T<sub>J</sub>, JUNCTION TEMPERATURE (°C)

**Figure 6. Gate Trigger Current Variation** 

Figure 7. Gate Trigger Voltage Variation



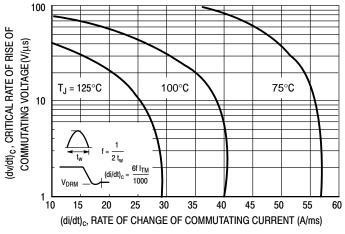
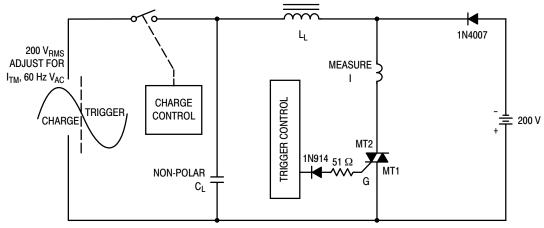


Figure 8. Critical Rate of Rise of Off-State Voltage (Exponential)

Figure 9. Critical Rate of Rise of Commutating Voltage

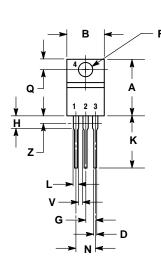


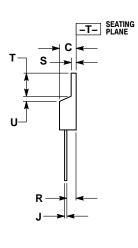
Note: Component values are for verification of rated (di/dt)<sub>c</sub>. See AN1048 for additional information.

Figure 10. Simplified Test Circuit to Measure the Critical Rate of Rise of Commutating Current (di/dt)

### PACKAGE DIMENSIONS

TO-220 CASE 221A-09 **ISSUE AH** 





- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. CONTROLLING DIMENSION: INCH.
- DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
Α	0.570	0.620	14.48	15.75
В	0.380	0.415	9.66	10.53
С	0.160	0.190	4.07	4.83
D	0.025	0.038	0.64	0.96
F	0.142	0.161	3.61	4.09
G	0.095	0.105	2.42	2.66
Н	0.110	0.161	2.80	4.10
J	0.014	0.024	0.36	0.61
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
N	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.39
T	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
٧	0.045		1.15	
Z		0.080		2.04

PIN 1. MAIN TERMINAL 1

- MAIN TERMINAL 2 2.
- GATE
- MAIN TERMINAL 2

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